



Qualcomm Technologies, Inc.

QCC743M Evaluation Kit 3.0

Reference Schematic

80-78830-41 Rev. AE

December 17, 2025

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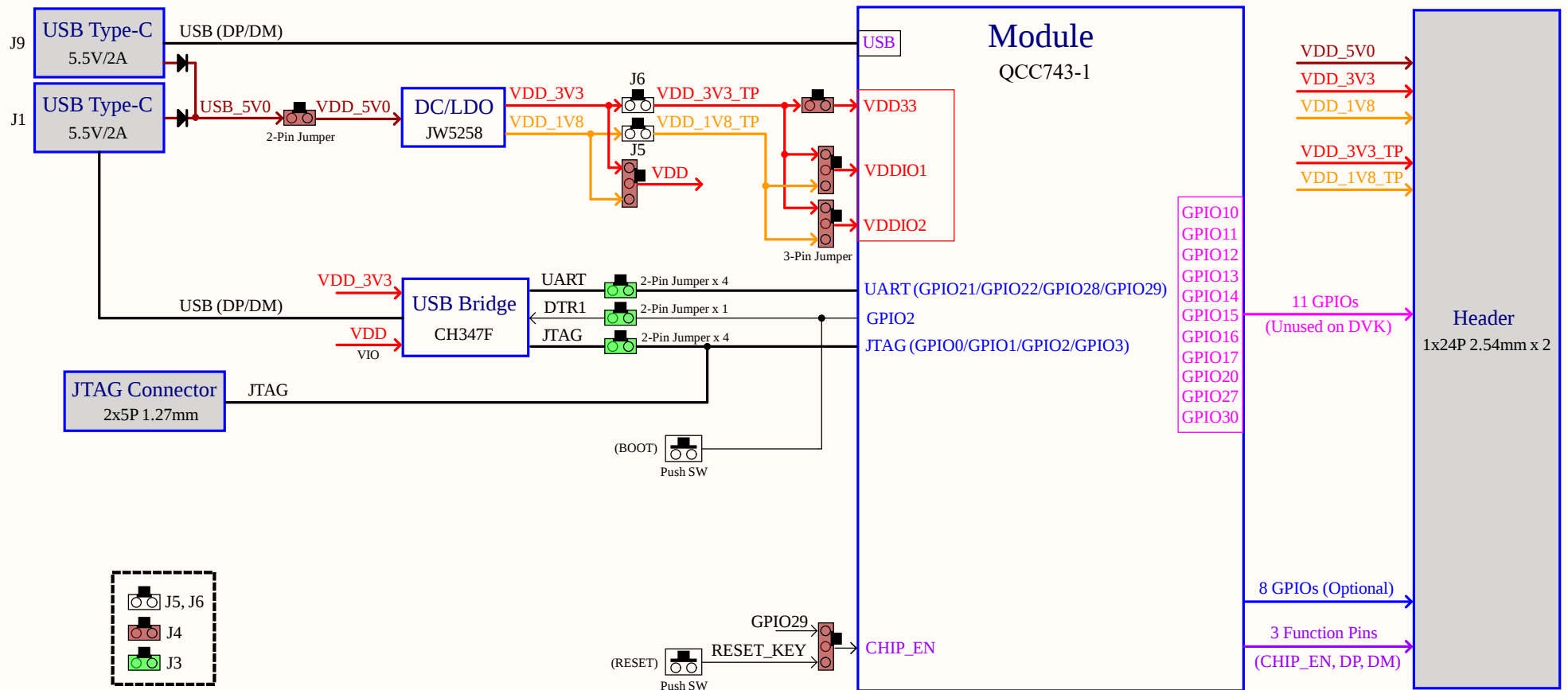
1 Reference schematic

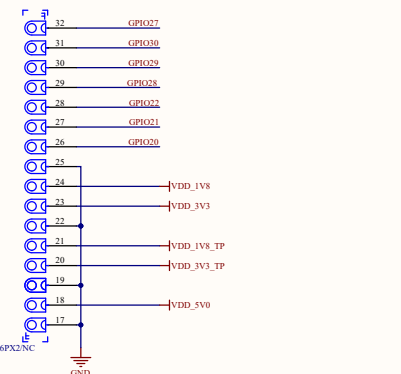
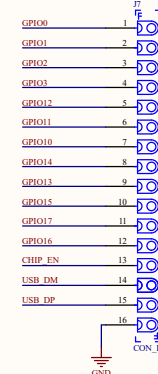
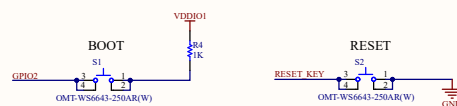
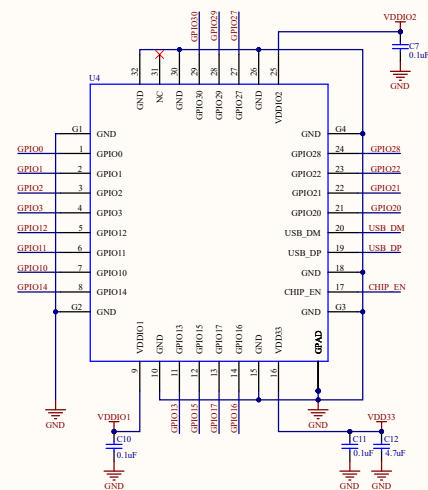
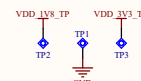
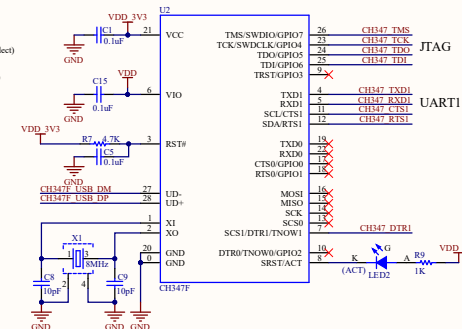
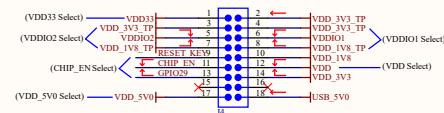
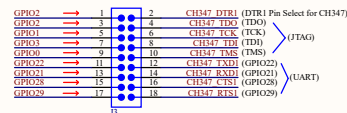
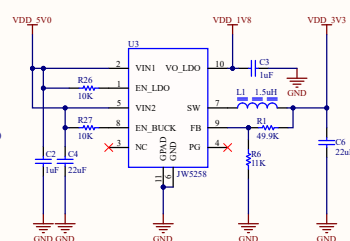
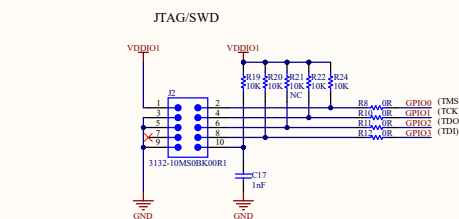
1.1 Introduction

This document includes the schematic for the QCC743M Evaluation Kit 3.0.

1.2 Schematic

This schematic is subject to change without notice, and is not optimized for production products due to its conservative design approach and internal test requirements.





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